

RX Family

M3S-TFAT-Tiny Memory Driver Interface Module

Firmware Integration Technology

Introduction

This Application Note describes the M3S-TFAT-Tiny Memory Driver Interface module which uses Firmware Integration Technology (FIT). This module uses as memory driver interface to combine RX Family Open source FAT filesystem M3S-TFAT-Tiny FIT (TFAT FIT) with each memory drivers. In this document, this module is referred to as the TFAT driver FIT module.

Please refer to the following URL to know the details about FIT Modules.

https://www.renesas.com/en-us/solutions/rx-applications/fit.html

In this document, the terms are used as follows.

TFAT FIT:

RX Family Open Source FAT File System M3S-TFAT-Tiny Module FIT (R20AN0038)

TFAT driver FIT:

RX Family M3S-TFAT-Tiny Memory Driver Interface Module FIT (R20AN0335)

TFAT:

M3S-TFAT-Tiny or generic term for TFAT FIT and TFAT driver FIT

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

This Application Note provides the driver interface corresponding to SD memory card (SD mode), SD memory card (SPI mode), USB memory, USB Mini, eMMC, Serial Flash memory. Please use with following FIT Modules.

Function	Product	Website
File system (*1)	TFAT FIT	http://www.renesas.com/mw/tfat-rx
SD memory card Drive (*2)	SD memory card Driver (SD mode)	https://www.renesas.com/driver/rtm0rx000 0dsdd
	SPI mode SD memory card Driver	
USB Driver (*2)	USB Basic Host and Peripheral Driver	http://www.renesas.com/driver/usb
	USB Host Mass Storage Class Driver (HMSC)	
USB Mini Driver (*2)	USB Basic Mini Host and Peripheral Driver (USB Mini Firmware)	http://www.renesas.com/driver/usb
	USB Host Mass Storage Class Driver for USB Mini Firmware	
eMMC Driver (*2)	MMC Mode MMCIF Driver	https://www.renesas.com/products/software-e-tools/software-os-middleware-driver/mmc/multimediacard-emmc-driver-for-rx-family.html
Serial Flash memory Driver (*2)	Clock Synchronous Control Module for Serial Flash Memory Access	https://www.renesas.com/products/software-e-tools/software-os-middleware-driver/serial-memory/spi-qspi-serial-flash-driver.html

^{*1} This is required.

Target Device

RX Family

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- · GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to "6.1 Confirmed Operation Environment".

^{*2} One module is required.

Related Documents

- RX Family Board Support Package Module Using Firmware Integration Technology (R01AN1685)
- RX Family Open Source FAT File System M3S-TFAT-Tiny Module Firmware Integration Technology (R20AN0038)
- RX Family SD Mode SD Memory Card Driver Firmware Integration Technology (R01AN4233)
- RX Family SPI Mode SD Memory Card Driver Firmware Integration Technology (R01AN6908)
- RX Family USB Basic Host and Peripheral Driver using Firmware Integration Technology (R01AN2025)
- RX Family USB Host Mass Storage Class Driver (HMSC) Firmware Integration Technology (R01AN2029)
 RX Family USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) Using Firmware Integration
 Technology (R01AN2166)
- RX Family USB Host Mass Storage Class Driver for USB Mini Firmware Using Firmware Integration Technology (R01AN2169)
- RX Family MMC Mode MMCIF Driver Firmware Integration Technology (R01AN4234)
- RX Family Clock Synchronous Control Module for Serial Flash Memory Access Firmware Integration Technology (R01AN2662)
- RX Family System Timer Module Firmware Integration Technology(R20AN0431)

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

Contents

1.	Overview	7
1.1	This Application Note	7
1.2	Structure of Application	7
1.2.1	Structure of Application	7
1.2.2	Structure of Software	8
1.3	API Overview	10
1.4	Limitations	10
2.	API Information	11
2.1	Hardware Requirements	11
2.2	Software Requirements	
2.3	Supported Toolchain	
2.4	Interrupt Vector	
2.5	Header Files	
2.6	Integer Types	11
2.7	Configuration Overview	
2.8	Code Size	14
2.9	Arguments	15
2.10	Return Values	15
2.11	Adding the FIT Module to Your Project	16
2.12	"for", "while" and "do while" statements	17
3.	API Functions	18
3.1	disk_initialize	19
3.2	disk status	20
3.3	disk_read	21
3.4		
	disk write	
3.5	-	23
3.5 3.6	disk_write	23 25
	disk_ioctl	23 25 27
3.6 3.7	disk_write disk_ioctl get_fattime drv_change_alloc	23 25 27 28
3.6 3.7 4.	disk_writedisk_ioctlget_fattimedrv_change_allocdrv_API	23 25 27 28
3.6 3.7 4. 4.1	disk_write	23 25 27 28 29
3.6 3.7 4.	disk_write disk_ioctl get_fattime drv_change_alloc Local API For USB Memory usb_disk_initialize	23 25 27 28 29 29
3.6 3.7 4. 4.1 4.1.1 4.1.2	disk_write disk_ioctl get_fattime drv_change_alloc Local API For USB Memory usb_disk_initialize usb_disk_read	23 25 27 28 29 30 31
3.6 3.7 4. 4.1 4.1.1 4.1.2 4.1.3	disk_write disk_ioctl get_fattime drv_change_alloc Local API For USB Memory usb_disk_initialize usb_disk_read usb_disk_write	23 25 27 28 29 30 31 32
3.6 3.7 4. 4.1 4.1.1 4.1.2 4.1.3	disk_write disk_ioctl get_fattime drv_change_alloc. Local API For USB Memory usb_disk_initialize usb_disk_read usb_disk_write usb_disk_ioctl	23 25 27 28 29 30 31
3.6 3.7 4. 4.1 4.1.2 4.1.3 4.1.4	disk_write	23 25 27 28 29 30 31 32 33 34
3.6 3.7 4. 4.1 4.1.1 4.1.2 4.1.3	disk_write	23 25 27 28 29 30 31 32 33 34

RX Family

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

4.2.1	sdmem_disk_initialize	37
4.2.2	sdmem_disk_read	38
4.2.3	sdmem_disk_write	39
4.2.4	sdmem_disk_ioctl	40
4.2.5	sdmem_disk_status	41
4.3	For SPI mode SD Memory Card	42
4.3.1	spi_sdmem_disk_initialize	43
4.3.2	spi_sdmem_disk_read	44
4.3.3	spi_sdmem_disk_write	45
4.3.4	spi_sdmem_disk_ioctl	46
4.3.5	spi_sdmem_disk_status	47
4.4	For USB Mini	48
4.4.1	usb_mini_disk_initialize	49
4.4.2	usb_mini_disk_read	50
4.4.3	usb_mini_disk_write	51
4.4.4	usb_mini_disk_ioctl	52
4.4.5	usb_mini_disk_status	53
4.4.6	R_usb_mini_hmsc_WaitLoop	54
4.5	For eMMC	55
4.5.1	mmcif_disk_initialize	56
4.5.2	mmcif_disk_read	57
4.5.3	mmcif_disk_write	58
4.5.4	mmcif_disk_ioctl	59
4.5.5	mmcif_disk_status	60
4.6	For Serial Flash Memory	61
4.6.1	flash_spi_disk_initialize	62
4.6.2	flash_spi_disk_read	63
4.6.3	flash_spi_disk_write	64
4.6.4	flash_spi_disk_ioctl	65
4.6.5	flash_spi_disk_status	66
4.6.6	flash_spi_1ms_interval	67
5. I	Pin Settings	68
6. /	Appendices	69
6.1	Confirmed Operation Environment	
6.2	Troubleshooting	
7. I	Reference Documents	74
Relat	ted Technical Updates	74

RX Family

	M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration	Technology
Revisior	n History	75

1. Overview

1.1 This Application Note

This Application describes memory driver interface combines TFAT FIT and each memory drivers. This Module can change the target of memory driver using config file.

The APIs provided by this module are called by TFAT FIT. It is no need to call by user.

The drive number controlled in TFAT FIT and the drive number controlled in device drivers (SD memory card driver etc.) are not equal. Therefore, this module has the conversion table for drive. Initial value can be configured, please refer to the section 3.7 drv_change_alloc if you change this as dynamic.

1.2 Structure of Application

1.2.1 Structure of Application

This application note includes files below.

Table 1.1 Structure of application note

file/f	older name	description
FITM	odules	
dri	ver_rx_v2.50.xml	FIT plug-in XML
dri	ver_rx_v2.50_extend.mdf	Smart Configurator setting File
dri	ver_rx_v2.50.zip	FIT plug-in ZIP
	configuration (r_config)	
	driver_rx_config.h	configuration file(default)
	FIT Module (driver_rx)	
	document(doc)	
	English(en)	
	r20an0335ej0250-rx-tfat.pdf	Application note (English)
	Japanese(ja)	
	r20an0335jj0250-rx-tfat.pdf	Application note (Japanese)
	source code(src)	
	readme (readme.txt)	readme
	r_tfat_driver_rx_if.h	Header file

1.2.2 Structure of Software

This product works with the TFAT FIT, the system timer module FIT, and various device driver FITs.

TFAT FIT is the main module of file system that contains open source the FatFs inside. The TFAT driver FIT has Wrapper functions inside and switches the I/O processing for the file system for each storage device. The user sets the storage device used by the TFAT driver FIT configuration settings and operates the file system via the TFAT FIT API.

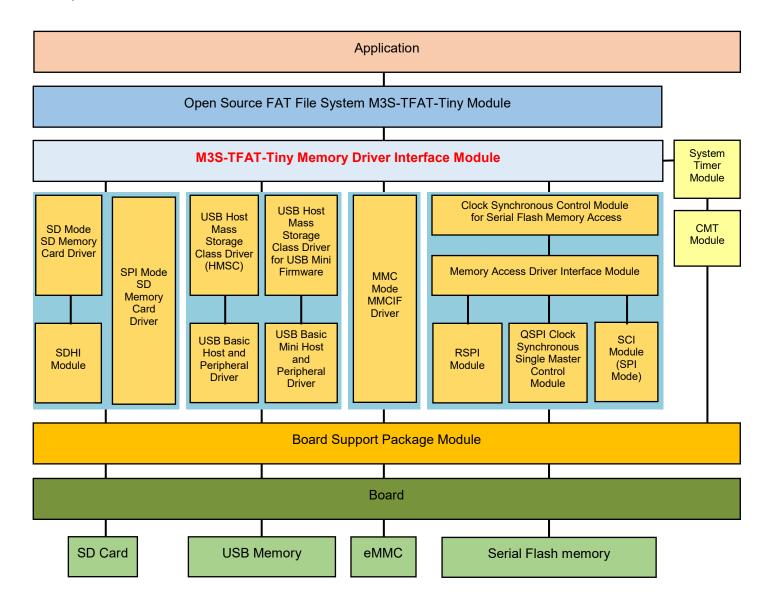


Fig.1-1 Structure of software

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

Table 1.2 Using FIT Modules version

Storage Device	Product	version
Common	Board Support Package (BSP)	7.51
	TFAT	4.12
	System Timer module	1.01
	CMT Module	5.70
SD memory card	SD Mode SD Memory Card Driver	3.00
(SD mode)	SDHI Module	2.11
SD memory card	SPI Mode SD Memory Card Driver	1.10
(SPI mode)	RSPI Module	3.50
	SCI Module (SPI Mode)	5.30
USB memory	USB Basic Host and Peripheral Driver	1.42
	USB Host Mass Storage Class Driver (HMSC)	1.42
	USB Basic Mini Host and Peripheral Driver	1.20
	USB Host Mass Storage Class Driver for USB Mini Firmware	1.20
eMMC	MMC Mode MMCIF Driver	1.10
Serial Flash memory	Clock Synchronous Control Module for Serial Flash Memory Access	3.30
	Memory Access Driver Interface Module	1.20
	RSPI Module	3.50
	QSPI Clock Synchronous Single Master Control Module	1.21
	SCI Module (SPI Mode)	5.30

1.3 API Overview

Table 1.3 shows the API Functions for this driver.

Table 1.3 API Functions

Function	Functional Overview
disk_initialize	Initialize disk drive.
disk_status	Get the information about disk drive status.
disk_read	Read the data from disk.
disk_write	Write the data to disk.
disk_ioctl	Control the drive.
get_fattime	Get the time information.
drv_change_alloc	Change the allocation of drive number between TFAT module and device driver.

1.4 Limitations

- (1) The target devices of TFAT are the devices supported by all the FITs that users use as lower layer than the TFAT. For the target devices of each FIT, refer to the respective application note.
- (2) Use Rev.1.20 or later for the USB Basic Mini Host and Peripheral Driver FIT and the USB Host Mass Storage Class Driver for USB Mini Firmware FIT. Because these revisions support RTOS.

2. API Information

2.1 Hardware Requirements

The microcontroller used must support the following functionality.

- USB
- SDHI
- CMT

2.2 Software Requirements

This FIT Module is dependent on the following packages:

- r bsp(Rev. 5.52 or later)
- r tfat rx (Rev.4.12 or later)
- r_sys_time_rx (Rev.1.01 or later)
- r_cmt_rx (Rev.4.40 or later)

The kind of memory driver to use can be set in r tfat driver rx config.h

2.3 Supported Toolchain

The supported toolchains of this module are depended on the toolchains of each memory driver.

2.4 Interrupt Vector

The TFAT driver FIT uses no interrupt vector.

2.5 Header Files

All API calls and their supporting interface definitions are located in "r_tfat_driver_rx_if.h". Build-time configuration options are selected or defined in the file "r_tfat_driver_rx_config.h".

2.6 Integer Types

This project uses ANSI C99 "Exact width integer types" in order to make the code clearer and more portable. These types are defined in "stdint.h".

2.7 Configuration Overview

The configuration options in this module are specified in "r_tfat_driver_rx_config.h". The option names and setting values are listed in the table below.

Configuration option	s in r_tfat_driver_rx_config.h
#define	The number of drives for USB.
TFAT_USB_DRIVE_NUM	Please set (0) if user does not use USB.
- Default value = (0)	
#define	The number of drives for SD memory card.
TFAT_SDMEM_DRIVE_NUM	Please set (0) if user does not use SD memory card.
- Default value = (0)	
#define	The number of drives for SPI mode SD memory card.
TFAT_SPI_SDMEM_DRIVE_NUM	Please set (0) if user does not use SPI mode SD
- Default value = (0)	memory card.
#define	The number of drives for USB Mini.
TFAT_USB_MINI_DRIVE_NUM	Please set (0) if user does not use USB Mini.
- Default value = (0)	
#define	The number of drives for eMMC.
TFAT_MMC_DRIVE_NUM	Please set (0) if user does not use eMMC.
- Default value = (0)	
#define	The number of drives for Serial Flash memory.
TFAT_SERIAL_FLASH_DRIVE_NUM	Please set (0) if user does not use Serial Flash
- Default value = (0)	memory.
#define	The sector size configuration when using TFAT and
TFAT_FLASH_SECTOR_SIZE	Serial Flash memory.
- Default value = (4096)	
	512 bytes = (512)
	1024 bytes = (1024)
	2048 bytes = (2048)
# 1 · C · ·	4096 bytes = (4096)
#define	This config allocates the device for each drive number.
TFAT_DRIVE_ALLOC_NUM_i	TI III (HOD (TEAT OTEN HOD)
i = 0-9	The driver for USB = (TFAT_CTRL_USB)
- Default value = (TFAT_CTRL_NONE)	The driver for USB Mini = (TFAT_CTRL_SDMEM)
	The driver for DSB Mini = (TFAT_CTRL_USB_MINI)
	The driver for Serial Flesh memory
	The driver for Serial Flash memory = (TFAT CTRL SERIAL FLASH)
	= (TFAT_CTRL_SERIAL_FLASH) The driver for "not using" = (TFAT_CTRL_NONE)
	The driver for flot using - (TPAT_CTRL_NOINE)
	This module uses these parameters for relating the
	drive number for TFAT FIT with the drive number of
	memory driver. The drive number is allocated
	ascending order. Please refer to the section 3.7
	drv_change_alloc if user change this in dynamic.

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

#define	When using RI600V4, input the mutex ID created by
RI600V4_MUTEX_ID_FOR_TFAT_DRIVE_ALLOC_NUM_i	RI600V4 configuration.
i = 0~9	This mutex is used by TFAT APIs to obtain the
- Default value = (0)	reentrancy (file/directory exclusive access) on a drive
	(logical volume).
	Please set (0) if not use RI600V4 or the memory drive.
	Duplication with ID "0" is allowed.

Please set (1 to 255) for mutex ID if use RI600V4 and the memory drive. Duplication with ID for other using drives is not allowed.

2.8 Code Size

The sizes of ROM, RAM and maximum stack usage associated with this module are listed below. Information is listed for a single representative device of the RX200 Series, and RX600 Series, respectively.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.7 Configuration Overview

The values in the table below are confirmed under the following conditions.

Module Revision: r_tfat_driver_rx rev.2.50

Compiler Version: Renesas Electronics C/C++ Compiler Package for RX Family V3.06.00

(The option of "lang = c99" is added to the default settings of the integrated development environment.)

GCC for Renesas RX 8.3.0.202405

(The option of "-std=gnu99" is added to the default settings of the integrated development environment.)

IAR C/C++ Compiler for Renesas RX version 5.10.1

(The default settings of the integrated development environment.)

Configuration Options: Default settings

ROM, RAM and Stack Code Sizes				
Device Category Memory Used				
		Renesas Compiler	GCC	IAR Compiler
RX113	ROM ^(Note)	6,516 bytes	7,688 bytes	8,657 bytes
	RAM ^(Note)	26 bytes	8 bytes	56 bytes
	STACK (Note)	192 bytes	-	348 bytes
RX231	ROM ^(Note)	6,517 bytes	7,688 bytes	8,659 bytes
	RAM ^(Note)	26 bytes	8 bytes	56 bytes
	STACK (Note)	192 bytes	-	348 bytes
RX65N	ROM ^(Note)	6,517 bytes	7,688 bytes	8,652 bytes
	RAM ^(Note)	26 bytes	8 bytes	58 bytes
	STACK (Note)	192 bytes	-	352 bytes

Note. The sizes of ROM, RAM, and stack of TFAT FIT are included.

2.9 Arguments

```
Please use definition of drive number when calling TFAT FIT.

typedef enum

{
    TFAT_DRIVE_NUM_0 = 0x00,
    TFAT_DRIVE_NUM_1,
    TFAT_DRIVE_NUM_2,
    TFAT_DRIVE_NUM_3,
    TFAT_DRIVE_NUM_4,
    TFAT_DRIVE_NUM_5,
    TFAT_DRIVE_NUM_6,
    TFAT_DRIVE_NUM_7,
    TFAT_DRIVE_NUM_7,
    TFAT_DRIVE_NUM_8,
    TFAT_DRIVE_NUM_9,

}TFAT_DRIVE_NUM_9,
```

2.10 Return Values

```
Return values are defined in "diskio.h" in TFAT FIT module.
/* Disk Status Bits (DSTATUS) */
typedef uint8 t DSTATUS;
         #define STA_NOINIT 0x01 /* Drive not initialized */
                                             /* No medium in the drive */
         #define STA_NODISK
                                  0x02
         #define STA_PROTECT 0x04 /* Write protected */
/* Results of Disk Functions */
typedef enum
{
       RES OK = 0, /* 0: Successful */
       RES_ERROR, /* 1: R/W Error */
       RES_WRPRT, /* 2: Write Protected */
       RES_NOTRDY,/* 3: Not Ready */
       RES_PARERR /* 4: Invalid Parameter */
} DRESULT;
```

2.11 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (2) or (4) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (3) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e² studio
 By using the Smart Configurator in e² studio, the FIT module is automatically added to your project.
 Refer to "RX Smart Configurator User's Guide: e² studio (R20AN0451)" for details.
- (2) Adding the FIT module to your project using the Smart Configurator in CS+ By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: CS+ (R20AN0470)" for details.
- (3) Adding the FIT module to your project in CS+ In CS+, please manually add the FIT module to your project. Refer to "RX Family Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)" for details.
- (4) Adding the FIT module to your project using the Smart Configurator in IAREW By using the Smart Configurator Standalone version, the FIT module is automatically added to your project. Refer to "RX Smart Configurator User's Guide: IAREW (R20AN0535)" for details.

2.12 "for", "while" and "do while" statements

In this module, "for", "while" and "do while" statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with "WAIT_LOOP" as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with "WAIT_LOOP".

The following shows example of description.

```
while statement example :
/* WAIT LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}

for statement example :
/* Initialize reference counters to 0. */
/* WAIT LOOP */
for (i = 0; i < BSP REG PROTECT TOTAL ITEMS; i++)
{
    g protect counters[i] = 0;
}

do while statement example :
/* Reset completion waiting */
do

{
    reg = phy read(ether channel, PHY REG CONTROL);
    count++;
} while ((reg & PHY CONTROL RESET) && (count < ETHER CFG PHY DELAY RESET)); /* WAIT LOOP */</pre>
```

3. API Functions

The following functions are called by TFAT FIT module. These functions (excluded some ones) call lower layer functions (4 Local API), which are prepared for each storage devices, according to the configuration. Note that application programs should not call the following APIs.

Table 3.1 Functions List

Function Name	Function Overview
disk_initialize	Initialize disk drive
disk_status	Get disk status
disk_read	Read sectors
disk_write	Write sectors
disk_ioctl	Control device dependent features
get_fattime	Get current time
drv_change_alloc	Change the allocation of drive number between TFAT module and device driver.

3.1 disk initialize

The disk initialize function is called to initialize the storage device.

format

Parameters

pdrv

Physical drive number to identify the target device. Always zero at single drive system.

Return Values

This function returns the current drive status flags as the result. For details of the drive status, refer to the disk_status function.

Properties

Prototyped in file "diskio.h".

Description

This function initializes the storage device and puts it ready to generic read/write. When the function succeeds, STA_NOINIT flag in the return value is cleared.

Remarks: This function needs to be under control of FatFs module. Application program MUST NOT call this function, or FAT structure on the volume can be broken. To re-initialize the filesystem, use f_mount function instead.

Example

None.

Special Notes:

None.

3.2 disk status

The disk_status function is called to inquire the current drive status.

format

Parameters

pdrv

Physical drive number to identify the target device. Always zero at single drive system.

Return Values

The current drive status is returned in combination of status flags described below. FatFs refers only STA_NOINIT and STA_PROTECT.

STA NOINIT

Indicates that the device has not been initialized and not ready to work. This flag is set on system reset, media removal or failure of disk_initialize function. It is cleared on disk_initialize function succeeded. Any media change that occurs asynchronously must be captured and reflect it to the status flags, or auto-mount function will not work correctly. If the system does not support media change detection, application program needs to explicitly re-mount the volume with f_mount function after each media change.

STA_NODISK

Indicates that no medium in the drive. This is always cleared at fixed disk drive. Note that FatFs does not refer this flag.

STA PROTECT

Indicates that the medium is write protected. This is always cleared at the drives without write protect function. Not valid if STA NODISK is set.

Properties

Prototyped in file "diskio.h".

Description

None.

Example

None.

Special Notes:

None

3.3 disk read

The disk_read function is called to read data from the sector(s) of storage device.

format

Parameters

pdrv

Physical drive number to identify the target device.

buff

Pointer to the first item of the byte array to store read data. Size of read data will be the sector size * count bytes.

sector

Start sector number in 32-bit logical block address (LBA).

count

Number of sectors to read.

Return Values

RES OK (0)

The function succeeded.

RES ERROR

An unrecoverable hard error occurred during the read operation.

RES_PARERR

Invalid parameter.

RES_NOTRDY

The device has not been initialized.

Properties

Prototyped in file "diskio.h".

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

Description

Read/write operation to the generic storage devices, such as memory card, hard disk and optical disk, is done in unit of block of data bytes called sector. FatFs supports the sector size in range of 512 to 4096 bytes. When FatFs is configured for fixed sector size (FF_MIN_SS == FF_MAX_SS, this is the most case), the read/write function must work at that sector size. When FatFs is configured for variable sector size (FF_MIN_SS < FF_MAX_SS), the sector size of medium is inquired with disk_ioctl function immediately following disk_initialize function succeeded.

There are some considerations about the memory address passed via buff. It is not that always aligned to word boundary because the argument is defined as BYTE*. The unaligned transfer request can occur at direct transfer. If the bus architecture, especially DMA controller, does not allow unaligned memory access, it should be solved in this function. If it is the case, there are some workarounds described below to avoid this issue.

Convert word transfer to byte transfer with some method in this function. - Recommended.

On the f_read() calls, avoid long read request that includes a whole of sector. - Any direct transfer never occurs.

On the f_read(fp, dat, btw, bw) calls, make sure that (((UINT)dat & 3) == (f_tell(fp) & 3)) is true. - Word alignment of buff is guaranteed.

Also the memory area may be out of reach in DMA. This is the case if it is in tightly coupled memory which is usually used for stack. Use double buffered transfer, or avoid to define any file I/O buffer includes FatFs and FIL structure as local variables where on the stack.

Generally, a multiple sector read request must not be split into single sector transactions to the storage device, or read throughput gets worse.

Example

None.

Special Notes:

None.

3.4 disk write

The disk write function is called to write data to the sector(s) of storage device.

format

Parameters

pdrv

Physical drive number to identify the target device.

buff

Pointer to the first item of the byte array to be written. The size of data to be written is sector size * count bytes.

sector

Start sector number in 32-bit logical block address (LBA).

count

Number of sectors to write.

Return Values

RES_OK (0)

The function succeeded.

RES_ERROR

An unrecoverable hard error occurred during the read operation.

RES_PARERR

Invalid parameter.

RES NOTRDY

The device has not been initialized.

Properties

Prototyped in file "diskio.h".

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

Description

The specified memory address is not that always aligned to word boundary because the argument is defined as BYTE*. For more information, refer to the description of disk_read function.

Generally, a multiple sector write request (count > 1) must not be split into single sector transactions to the storage device, or the file write throughput will be drastically decreased.

FatFs expects delayed write function of the disk control layer. The write operation to the media does not need to be completed at return from this function by what write operation is in progress or data is only stored into the write-back cache. But write data on the buff is invalid after return from this function. The write completion request is done by CTRL_SYNC command of disk_ioctl function. Therefore, if a delayed write function is implemented, the write throughput of the filesystem will be improved.

Remarks: Application program MUST NOT call this function, or FAT structure on the volume can be collapsed.

Example

None.

Special Notes:

This function is not needed when FF_FS_READONLY = 1.

3.5 disk ioctl

The disk_ioctl function is called to control device specific features and miscellaneous functions other than generic read/write.

format

Parameters

pdrv

Physical drive number to identify the target device.

cmd

Command code.

buff

Pointer to the parameter depends on the command code. Do not care if the command has no parameter to be passed.

Return Values

RES_OK (0)

The function succeeded.

RES_ERROR

An error occurred.

RES PARERR

The command code or parameter is invalid.

RES NOTRDY

The device has not been initialized.

Properties

Prototyped in file "diskio.h".

Description

The FatFs module requires only five device general-purpose commands described below.

Table 3.2 general-purpose commands

Command	Describe
CTRL_SYNC	Make sure that the device has finished pending write process. If the disk I/O module or storage device has a write-back cache, the cached data marked dirty must be written back to the media immediately. Nothing to do for this command if each write operation to the media is completed within the disk_write function.
GET_SECTOR_SIZE	Returns number of available sectors on the drive into the DWORD variable pointed by buff. This command is used by f_mkfs and f_fdisk function to determine the volume/partition size to be created. Required at FF_USE_MKFS = 1.
GET_SECTOR_COUNT	Returns sector size of the device into the WORD variable pointed by buff. Valid return values for this command are 512, 1024, 2048 and 4096. This command is required only if FF_MAX_SS > FF_MIN_SS. When FF_MAX_SS = FF_MIN_SS, this command is never used and the device must work at that sector size.
GET_BLOCK_SIZE	Returns erase block size of the flash memory media in unit of sector into the DWORD variable pointed by buff. The allowable value is 1 to 32768 in power of 2. Return 1 if the erase block size is unknown or non flash memory media. This command is used by only f_mkfs function and it attempts to align data area on the erase block boundary. Required at FF_USE_MKFS = 1.
CTRL_TRIM	Informs the device the data on the block of sectors is no longer needed and it can be erased. The sector block is specified by a DWORD array { <start sector="">, <end sector="">} pointed by buff. This is an identical command to Trim of ATA device. Nothing to do for this command if this function is not supported or not a flash memory device. FatFs does not check the result code and the file function is not affected even if the sector block was not erased well. This command is called on remove a cluster chain and in the f_mkfs function. Required at FF_USE_TRIM = 1.</end></start>

Example

None.

Special Notes:

The disk_ioctl function is not needed when FF_FS_READONLY = 1 and FF_MAX_SS = FF_MIN_SS.

3.6 get_fattime

The get fattime function is called to get the current time.

format

```
DWORD get fattime (void);
```

Parameters

None,

Return Values

Current local time shall be returned as bit-fields packed into a DWORD value. The bit fields are as follows:

```
bit31:25
```

Year origin from the 1980 (0..127, e.g. 37 for 2017)

bit24:21

Month (1..12)

bit20:16

Day of the month (1..31)

bit15:11

Hour (0..23)

bit10:5

Minute (0..59)

bit4:0

Second / 2 (0..29, e.g. 25 for 50)

Properties

Prototyped in file "ff.h".

Description

The get_fattime function shall return any valid time even if the system does not support a real time clock. If a zero is returned, the file will not have a valid timestamp.

Example

None.

Special Notes:

This function is not needed when FF_FS_READONLY = 1 or FF_FS_NORTC = 1.

3.7 drv_change_alloc

The drv_change_alloc function changes a drive's allocation. This function has nothing to do with FatFs and is a unique API of Renesas.

format

Parameters

RES_OK(0)

The function succeeded.

RES PARERR

The specified value of tfat_drv is invalid.

Return Values

tfat drv

Th physical drive number for TFAT FIT.

dev_type

The device define type (TFAT_USB_DRIVE_NUM, TFAT_SDMEM_DRIVE_NUM, or TFAT_USB_MINI_DRIVE_NUM).

dev_drv_num

The drive number/device channel for device driver.

Properties

Prototyped in file "r_tfat_driver_rx_if.h".

Description

The drive used for TFAT FIT is specified by the TFAT_DRIVE_ALLOC_NUM_i definition in r_tfat_driver_rx_config.h, and the drive number for TFAT FIT is associated with the drive number of the memory driver.

Drive numbers for memory drivers are automatically assigned in ascending order.

Use this function if you want to change the association dynamically.

Example

None.

Special Notes:

None.

4. Local API

There are functions for SD memory card (SD mode), SD memory card (SPI mode), USB memory, USB Mini, eMMC, and Serial Flash memory. Each function calls memory driver functions.

4.1 For USB Memory

Table 4.1 **Functions List** are called when Section 2.7 Configuration Overview TFAT_USB_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i(i=0-9) have the settings "TFAT_CTRL_USB".

Table 4.1 Functions List

Function name	Function Overview
usb_disk_initialize	Initialize disk drive
usb_disk_read	Read sectors
usb_disk_write	Write sectors
usb_disk_ioctl	Control device dependent features
usb_disk_status	Get disk status

Table 4.2 Other Functions List

Function name	Function Overview
R_usb_hmsc_WaitLoop	Wait for read and write

4.1.1 usb_disk_initialize

This function initializes the disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS usb disk initialize (uint8 t pdrv);
```

Parameters

pdrv input Specifies the initialize drive number.

Return Value

TFAT RES OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This API does not call USB driver initialize function because of USB driver limitation (1 time call is only accepted). Please call USB driver initialize function in user program.

4.1.2 usb_disk_read

This function reads the data from disk.

Format

Parameters

pdrv input Specifies the physical drive number.

buff output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector input Specifies the start sector number in logical block address (LBA). count input Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

This function reads the data from disk drive. The position of read data is specified using this function argument.

4.1.3 usb_disk_write

This function writes the data to the disk.

Format

Parameters

pdrv input Specifies the physical drive number. buff input Pointer to the data to be written.

sector input Specifies the start sector number in logical block address (LBA). count input Specifies number of sectors to write. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

This function writes the data to the disk drive. The position of write data is specified using this function argument.

4.1.4 usb_disk_ioctl

This function controls the drive.

Format

Parameters

pdrv input Specifies the physical drive number.

cmd input Specifies the command code. The command code will always be 0.

buff input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The usb_disk_ioctl function is used only by the f_sync function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

For users who wish to use f_sync function in their applications, this particular driver interface function will have to be implemented. This driver function should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

4.1.5 usb_disk_status

This function gets the information about disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS usb disk status (uint8 t pdrv );
```

Parameters

pdrv input Specifies the physical drive number.

Return Value

TFAT RES OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

M3S-TFAT-Tiny Memory Driver Interface Module Firmware Integration Technology

4.1.6 R_usb_hmsc_WaitLoop

This function waits the data read/write.

Format

void R_usb_hmsc_WaitLoop (void);

Parameters

None.

Return Value

None.

Description

Please refer to the USB driver document for details.

4.2 For SD Memory Card

Table 4.3 **List of Functions** are called when Section 2.7 Configuration Overview TFAT_SDMEM_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i (i=0-9) have the settings "TFAT_CTRL_SDMEM".

Table 4.3 List of Functions

Function Name	Outline
sdmem_disk_initialize	Initialize disk drive
sdmem_disk_read	Read sectors
sdmem_disk_write	Write sectors
sdmem_disk_ioctl	Control device dependent features
sdmem_disk_status	Get disk status

[Notice about SD memory card]

This module does not execute mount process and VDD power supply process. Please refer to the SD memory card module document and please implement. Otherwise, this module works abnormally.

4.2.1 sdmem_disk_initialize

This function initializes the disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS sdmem_disk_initialize (uint8_t drive);
```

Parameters

drive input Specifies the initialize drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function does not execute the SD memory card driver initialize. Please implement SD memory card initialize code in user code.

4.2.2 sdmem_disk_read

This function reads the data from disk.

Format

Parameters

drive input Specifies the physical drive number.

buffer output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Read data from SD memory by block.

4.2.3 sdmem_disk_write

This function writes the data to the disk.

Format

Parameters

drive input Specifies the physical drive number. buffer input Pointer to the data to be written.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to write. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Write the data to the SD memory by block.

4.2.4 sdmem_disk_ioctl

This function controls the drive.

Format

Parameters

drive input Specifies the physical drive number.

command input Specifies the command code. The command code will always be 0.

buffer input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The sdmem_disk_ioctl function is used only by the f_sync function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

For users who wish to use f_sync function in their applications, this particular driver interface function will have to be implemented. This driver function should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

4.2.5 sdmem_disk_status

This function gets the disk drive status.

Format

```
#include "r_tfat_drv_if_dev.h"
  DSTATUS sdmem_disk_status (uint8_t drive
);
```

Parameters

drive input Specifies the physical drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

4.3 For SPI mode SD Memory Card

Table 4.3 **List of Functions** are called when Section 2.7 Configuration Overview TFAT_SPI_SDMEM_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i (i=0-9) have the settings "TFAT_CTRL_SPI_SDMEM".

Table 4.3 Functions List

Function Name	Outline
spi_sdmem_disk_initialize	Initialize disk drive
spi_sdmem_disk_read	Read sectors
spi_sdmem_disk_write	Write sectors
spi_sdmem_disk_ioctl	Control device dependent features
spi_sdmem_disk_status	Get disk status

[Notice about SPI mode SD memory card]

This module does not execute mount process and VDD power supply process. Please refer to the SPI mode SD memory card module document and please implement. Otherwise, this module works abnormally.

4.3.1 spi_sdmem_disk_initialize

This function initializes the disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS spi_sdmem_disk_initialize (uint8_t drive);
```

Parameters

drive input Specifies the initialize drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function does not execute the SPI mode SD memory card driver initialize. Please implement SPI mode SD memory card initialize code in user code.

4.3.2 spi_sdmem_disk_read

This function reads the data from disk.

Format

Parameters

drive input Specifies the physical drive number.

buffer output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Read data from SPI mode SD memory by block.

4.3.3 spi_sdmem_disk_write

This function writes the data to the disk.

Format

Parameters

drive input Specifies the physical drive number. buffer input Pointer to the data to be written.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to write. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Write the data to the SPI mode SD memory by block.

4.3.4 spi_sdmem_disk_ioctl

This function controls the drive.

Format

Parameters

drive input Specifies the physical drive number.

command input Specifies the command code. The command code will always be 0.

buffer input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The spi_sdmem_disk_ioctl function is used only by the f_sync function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

For users who wish to use f_sync function in their applications, this particular driver interface function will have to be implemented. This driver function should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

4.3.5 spi_sdmem_disk_status

This function gets the disk drive status.

Format

```
#include "r_tfat_drv_if_dev.h"
  DSTATUS spi_sdmem_disk_status (uint8_t drive
);
```

Parameters

drive input Specifies the physical drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

4.4 For USB Mini

Table 4.4 **Functions List** are called when Section 2.7 Configuration Overview TFAT_USB_MINI_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i(i=0-9) have the settings "TFAT_CTRL_USB_MINI".

Table 4.4 Functions List

Function name	Function Overview
usb_mini_disk_initialize	Initialize disk drive
usb_mini_disk_read	Read sectors
usb_mini_disk_write	Write sectors
usb_mini_disk_ioctl	Control device dependent features
usb_mini_disk_status	Get disk status

Table 4.5 Other Function List

Function name	Function Overview
R_usb_mini_hmsc_WaitLoop	Wait for read and write

usb_mini_disk_initialize

This function initializes the disk drive.

Format

```
#include "r tfat drv if dev.h"
DSTATUS usb mini_disk_initialize (uint8_t drive);
```

Parameters

Specifies the initialize drive number. drive input

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT RES OK 2.10 Return Values.

DSTATUS status of the disk after function execution as explained in section

Description

This API does not call USB driver initialize function because of USB driver limitation (1 time call is only accepted). Please call USB driver initialize function in user program.

4.4.2 usb_mini_disk_read

This function reads the data from disk.

Format

Parameters

drive input Specifies the physical drive number.

buffer output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector_number input Specifies the start sector number in logical block address (LBA). sector_count input Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

This function reads the data from disk drive. The position of read data is specified using this function argument.

4.4.3 usb_mini_disk_write

This function writes the data to the disk.

Format

Parameters

drive input Specifies the physical drive number. buffer input Pointer to the data to be written.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

This function writes the data to the disk drive. The position of write data is specified using this function argument.

4.4.4 usb_mini_disk_ioctl

This function controls the drive.

Format

Parameters

drive input Specifies the physical drive number.

command input Specifies the command code. The command code will always be 0.

buffer input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The usb_mini_disk_ioctl function is used only by the f_sync function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

For users who wish to use f_sync function in their applications, this particular driver interface function will have to be implemented. This driver function should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

4.4.5 usb_mini_disk_status

This function gets the information about disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS usb_mini_disk_status (uint8_t drive);
```

Parameters

drive input Specifies the physical drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT RES OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

4.4.6 R_usb_mini_hmsc_WaitLoop

This function waits the data read/write.

Format

```
void R_usb_mini_hmsc_WaitLoop (void );
```

Parameters

None.

Return Value

None.

Description

Please refer to the USB driver document for details.

4.5 For eMMC

Table 4.6 List of Functions are called when Section 2.7 Configuration Overview TFAT_MMC_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i (i=0-9) have the settings "TFAT_CTRL_MMC".

Table 4.6 List of Functions

Function Name	Outline
mmcif_disk_initialize	Initialize disk drive
mmcif_disk_read	Read sectors
mmcif_disk_write	Write sectors
mmcif_disk_ioctl	Control device dependent features
mmcif_disk_status	Get disk status

4.5.1 mmcif_disk_initialize

This function initializes the disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS mmcif_disk_initialize (uint8_t drive);
```

Parameters

drive input Specifies the initialize drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function does not execute the eMMC driver initialize. Please implement eMMC initialize code in user code.

4.5.2 mmcif_disk_read

This function reads the data from disk.

Format

Parameters

drive input Specifies the physical drive number.

buffer output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Read data from eMMC by block.

4.5.3 mmcif_disk_write

This function writes the data to the disk.

Format

Parameters

drive input Specifies the physical drive number. buffer input Pointer to the data to be written.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to write. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Write the data to the eMMC by block.

4.5.4 mmcif_disk_ioctl

This function controls the drive.

Format

Parameters

drive input Specifies the physical drive number.

command input Specifies the command code. The command code will always be 0.

buffer input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The mmcif_disk_ioctl function is used only by the f_sync or f_mkfs function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

The command CTRL_SYNC should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

For other commands, refer to Table 3.2 general-purpose commands.

4.5.5 mmcif_disk_status

This function gets the disk drive status.

Format

```
#include "r_tfat_drv_if_dev.h"
  DSTATUS mmcif_disk_status (uint8_t drive
);
```

Parameters

drive input Specifies the physical drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

4.6 For Serial Flash Memory

Table 4.7 List of Functions are called when Section 2.7 Configuration Overview TFAT_SERIAL_FLASH_DRIVE_NUM and TFAT_DRIVE_ALLOC_NUM_i (i=0-9) have the settings "TFAT_CTRL_SERIAL_FLASH".

Table 4.7 List of Functions

Function Name	Outline
flash_spi_disk_initialize	Initialize disk drive
flash_spi_disk_read	Read sectors
flash_spi_disk_write	Write sectors
flash_spi_disk_ioctl	Control device dependent features
flash_spi_disk_status	Get disk status

Table 4.8 Other Functions List

Function name	Function Overview
flash_spi_1ms_interval	Update internal timer per 1 ms

4.6.1 flash_spi_disk_initialize

This function initializes the disk drive.

Format

```
#include "r_tfat_drv_if_dev.h"
DSTATUS flash_spi_disk_initialize (uint8_t drive);
```

Parameters

drive input Specifies the initialize drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function does not execute the Serial Flash memory driver initialize. Please implement Serial Flash memory initialize code in user code.

4.6.2 flash_spi_disk_read

This function reads the data from disk.

Format

Parameters

drive input Specifies the physical drive number.

buffer output Pointer to the read buffer to store the read data. A buffer of the size equal to

the number of bytes to be read is required.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to read. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Read data from Serial Flash memory by block.

4.6.3 flash_spi_disk_write

This function writes the data to the disk.

Format

Parameters

drive input Specifies the physical drive number. buffer input Pointer to the data to be written.

sector_number input Specifies the start sector number in logical block address (LBA). Specifies number of sectors to write. The value can be 1 to 255.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

Write the data to the Serial Flash memory by block.

4.6.4 flash_spi_disk_ioctl

This function controls the drive.

Format

Parameters

drive input Specifies the physical drive number.

command input Specifies the command code. The command code will always be 0.

buffer input Pointer should always be a NULL pointer.

Return Value

DRESULT Result of the function execution as explained in section 2.10 Return Values.

Description

The flash_spi_disk_ioctl function is used only by the f_sync or f_mkfs function amongst all the TFAT FIT functions. Users who do not plan to use f_sync function in their applications can skip the implementation for this particular driver interface function.

For users who wish to use f_sync function in their applications, the command CTRL_SYNC has to be implemented.

The command CTRL_SYNC should consist of the code to finish off any pending write process. If the disk i/o module has a write back cache, the dirty sector must be flushed immediately. The f_sync function will perform a save operation to the unsaved data related to the file object passed as argument.

For other commands, refer to Table 3.2 general-purpose commands.

4.6.5 flash spi disk status

This function gets the disk drive status.

Format

```
#include "r_tfat_drv_if_dev.h"
  DSTATUS flash_spi_disk_status (uint8_t drive
);
```

Parameters

drive input Specifies the physical drive number.

Return Value

TFAT_RES_OK Normal termination.

Other than TFAT_RES_OK DSTATUS status of the disk after function execution

as explained in section 2.10 Return Values.

Description

This function should consist of the code that checks the disk and returns the current disk status. The disk status can have any of the three values as explained in section 2.10 Return Values. The disk status can be returned by updating the return value with the macros related to disk status.

4.6.6 flash_spi_1ms_interval

This function updates internal timer per 1 ms.

Format

```
#include "r_tfat_drv_if_dev.h"
void flash_spi_1ms_interval (void);
```

Parameters

None.

Return Value

None.

Description

This function updates internal timer of the TFAT driver FIT per 1 ms. This timer is used to check the busy status of the serial flash memory.

5. Pin Settings

The TFAT driver FIT has no pin settings.

6. Appendices

6.1 Confirmed Operation Environment

This section describes operation confirmation environment for TFAT driver FIT.

Table 6.1 Confirmed Operation Environment (Rev.1.05 for SD Memory Card Driver and USB Mini Driver)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio V6.3.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.08.00
	Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.05
Board used	Renesas Starter Kit+ for RX64M (product No.:R0K50564MSxxxxx)
	Renesas Starter Kit for RX231 (product No.:R0K505231Sxxxxx)
RTOS	None

Table 6.2 Confirmed Operation Environment (Rev.1.05 for USB Driver)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio V7.3.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00
	Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.05
Board used	Renesas Starter Kit+ for RX64M (product No.:R0K50564MSxxxxx)
RTOS	None

Table 6.3 Confirmed Operation Environment (Rev. 2.00)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 7.7.0
environment	IAR Embedded Workbench for Renesas RX 4.13.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99
	GCC for Renesas RX 8.3.0.201904 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.13.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.00
Board used	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)
RTOS	FreeRTOS V10.0.00
	RI600V4 V1.06.00

Table 6.4 Confirmed Operation Environment (Rev. 2.10)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 7.8.0
environment	IAR Embedded Workbench for Renesas RX 4.14.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99
	GCC for Renesas RX 8.3.0.201904 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.14.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.10
Board used	Renesas Starter Kit for RX231 (product No.: RTK55231xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx
	Renesas Starter Kit+ for RX64M (product No.: RTK5564Mxxxxxxxxxxx)
RTOS	FreeRTOS V10.0.00
	RI600V4 V1.06.00

Table 6.5 Confirmed Operation Environment (Rev. 2.20)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 2020-07
environment	IAR Embedded Workbench for Renesas RX 4.14.1
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99 GCC for Renesas RX 8.3.0.202002 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.14.1 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.20
Board used	Renesas Starter Kit for RX231 (product No.: RTK55231xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx
RTOS	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx) FreeRTOS V10.0.03 RI600V4 V1.06.00

Table 6.6 Confirmed Operation Environment (Rev. 2.30)

Item	Contents
Integrated development	Renesas Electronics e ² studio Version 2023-07
environment	IAR Embedded Workbench for Renesas RX 4.20.3
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.05.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99
	GCC for Renesas RX 8.3.0.202305 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.30
Board used	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxxx)
RTOS	FreeRTOS V10.4.3
	RI600V4 V1.06.01

Table 6.7 Confirmed Operation Environment (Rev. 2.40)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 2023-10			
environment	IAR Embedded Workbench for Renesas RX 4.20.3			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.05.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 8.3.0.202305 Compiler option: The following option is added to the default settings of the integrated development environmentstd=gnu99			
	IAR C/C++ Compiler for Renesas RX version 4.20.3 Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module	dule Rev.2.40			
Board used	Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxx)			
RTOS None				

Table 6.8 Confirmed Operation Environment (Rev. 2.50)

Item	Contents			
Integrated development	Renesas Electronics e ² studio Version 2024-07			
environment	IAR Embedded Workbench for Renesas RX 5.10.1			
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.06.00 Compiler option: The following option is added to the default settings of the integrated development environmentlang = c99			
	GCC for Renesas RX 8.3.0.202405 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99			
	IAR C/C++ Compiler for Renesas RX version 5.10.1 Compiler option: The default settings of the integrated development environment.			
Endian	Big endian/little endian			
Revision of the module				
Board used	Renesas Target Board for RX140 (product No.: RTK5RX1400xxxxxxxx) Renesas Starter Kit+ for RX140 (product No.: RTK551406Bxxxxxxxxx) Renesas Starter Kit+ for RX64M (product No.: R0K50564Mxxxxxx) Renesas Starter Kit+ for RX65N-2MB (product No.: RTK50565Nxxxxxxxxxxx) Renesas Starter Kit+ for RX72M (product No.: RTK5572Mxxxxxxxxxxx)			
RTOS	FreeRTOS V10.4.3			

6.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

Using e² studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using this FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

- (2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r_tfat_driver_rx module.
 - A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.
- (3) Q: I have added the FIT module to the project and built it. Then I got an error for when the configuration setting is wrong.
 - A: The setting in the file "r_tfat_driver_rx_config.h" may be wrong. Check the file "r_tfat_driver_rx_config.h". If there is a wrong setting, set the correct value for that. Refer to 2.7 Configuration Overview for details.
- (4) Q: The pin setting is supposed to be done, but this does not look like it.
 - A: The pin setting may not be performed correctly. When using this FIT module, the pin setting must be performed. Refer to 5 Pin Settings for details.

7. Reference Documents

User's Manual: Hardware

The latest versions can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

User's Manual: Development Tools

RX Family C/C++ Compiler CC-RX User's Manual (R20UT3248)

The latest version can be downloaded from the Renesas Electronics website.

Related Technical Updates

This module reflects no technical updates.

Revision History

		Description	1
Rev.	Date	Page	Summary
1.00	Dec 01, 2014	rage	First edition issued
1.00	Jan 05, 2015	-	Added support MCUs.
1.02	Jun 30, 2015	-	Added support MCUS. Added support MCU RX231.
1.02	Oct 01, 2016		Added support RX family.
	·	-	
1.04	Jun 29, 2018	-	1.2.2 Fig.1-1 Added System timer and CMT modules. 1.3 Added API Overview
			2.6 Changed SD memory card define name.
			2.7 Added Code Size
			3.6 Modified get_fattime() description.
			4.2.1-4.2.5 Changed API name.
			5 Added Appendices
			6 Added Reference Documents
1.05	Dec 14, 2018	-	Revision up by USB driver supporting RTOS.
2.00	Feb. 25, 2020	+	Supported the following compilers.
2.00	Feb. 23, 2020	-	- GCC for Renesas RX
			- IAR C/C++ Compiler for Renesas RX
			Supported the following RTOS.
			- FreeRTOS
			- RI600V4
			Removed "R_TFAT_" from the function names.
2.10	Jul. 27, 2020		Supported the following storage devices.
2.10	Jul. 27, 2020		- eMMC
			- Serial Flash memory
			Supported the format function for following storage devices.
			- eMMC
			- Serial Flash memory
			Supported sector size 4096 bytes.
			Supported the following RTOS with using USB mini FIT.
			- FreeRTOS
			- RI600V4
2.20	Sep. 10, 2020	-	Supported the format function for following storage devices.
	' '		- SD memory card
			- USB
		Program	Modified the TFAT driver FIT module due to the software issue
			[Description]
			The BLOCK SIZE value of eMMC obtained by the
			GET_BLOCK_SIZE command is incorrect.
			[Conditions]
			The following two conditions are met:
			- Rev.2.10 version of the TFAT driver FIT module is used.
			- Format eMMC.
			[Workaround]
			Please use Rev.2.20 or a later version of the TFAT driver FIT
			module.

		Description		
Rev.	Date	Page	Summary	
2.20	Sep. 10, 2020	Program	Modified the TFAT driver FIT module due to the software issue	
			[Description] The BLOCK SIZE value of Serial Flash memory obtained by the GET_BLOCK_SIZE command is incorrect. If the size of the Serial Flash memory is very large, the format processing time will be long and the available memory will be small.	
			[Conditions] The following two conditions are met: - Rev.2.10 version of the TFAT driver FIT module is used Format Serial Flash memory.	
			[Workaround] Please use Rev.2.20 or a later version of the TFAT driver FIT module.	
2.30	Aug. 31, 2023	14	Deleted the description of FIT configurator from "2.11 Adding the FIT Module to Your Project"	
		18, 20	Updated the open source base version from V0.13c to V0.15.	
		Program	Updated the open source base version from V0.13c to V0.15.	
2.40	Dec. 15, 2023	8 12	Updated FIT module version for Table 1.2 Updated the sector size configuration option when using TFAT and Serial Flash memory.	
		13	Updated the section of 2.8 Code Size.	
		16	Added 2.12 "for", "while" and "do while" statements.	
		65	6.1 Confirmed Operation Environment:	
			Added Table for Rev.2.40	
		Program	Added support Serial Flash FAT sector size selectable.	
2.50	Sep 16, 2024	2, 8, 29 3	Updated to support SPI mode SD card. Added related document for SPI mode SD card module.	
		7	Updated FIT module version	
		9	Updated to support SPI mode SD card module for Table 1.2 Updated FIT module version for Table 1.2	
		12	Added configuration option when using TFAT and SPI mode SD card memory.	
		14	Updated the section of 2.8 Code Size.	
		42-47	Added support SPI mode SD card	
		72	6.1 Confirmed Operation Environment:	
			Added Table for Rev.2.50	
		Program	Added support SPI mode SD card.	

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

Notice

- 1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
- 2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
- 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others
- 4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
- 5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
- 6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.

Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.

- 7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
- 8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
- 12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
- 13. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
- (Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
- (Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.5.0-1 October 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/.